

IEEE 802.3 Beyond 10km Optical PHYs Study Group

200GbE / 40km CSD Response Ad Hoc Teleconference, 03-Apr 2018

Approved Meeting Minutes, Prepared by John D'Ambrosia

Chaired by David Lewis

Meeting called to order at 10:01 am ET

Presentation – Agenda and General Information

Presenter: David Lewis, Lumentum

URL: http://www.ieee802.org/3/B10K/public/adhoc/18_0403/agenda_b10k_01_180403.pdf

Chair asked everyone to reply to email sent out with name and employer / affiliation. Chair noted that this information was being collected for the purpose of recording attendance in the ad hoc teleconference minutes.

PRE-PAR Patent Policy slide was shown -

<https://development.standards.ieee.org/myproject/Public/mytools/mob/preparslides.pdf>

IEEE 802 Participation slide was shown - <https://mentor.ieee.org/802-ec/dcn/16/ec-16-0180-05-00EC-ieee-802-participation-slide.pdf>.

Presentation – 200 GbE 40km Objective 5C Study Group Discussion

Presenter: David Lewis, Lumentum

URL: http://www.ieee802.org/3/B10K/public/adhoc/18_0403/lewis_b10k_01_180403.pdf

There was general discussion regarding the presentation. The presentation was only reviewed up to the second main bullet of Slide #7. Updates to proposed responses considered were captured in updated presentation, noted below –

URL: http://www.ieee802.org/3/B10K/public/adhoc/18_0403/lewis_b10k_02_180403.pdf

During discussion of Broad Market Potential – the response related to the CFI was discussed, as there were two CFIs that drove the formation of the current Study Group. It was suggested to look at the average participation per study group meeting. D'Ambrosia took an action item to give David Lewis the attendance numbers.

Meeting adjourned approximately 11:00am.

Call Participants

John D'Ambrosia	Futurewei, Subsidiary of Huawei	Futurewei, Subsidiary of Huawei
David Lewis	Lumentum	Lumentum
Curtis Knittle	CableLabs	CableLabs
Steve Trowbridge	Nokia	Nokia
Phong Pham	US Conec Ltd.	US Conec Ltd.
Gary Nicholl	Cisco	Cisco
Ted Sprague	Infinera	Infinera
David Law	HPE	HPE
Derek Cassidy	ICRG-IET	ICRG-IET
Tom Williams	Acacia Communications	Acacia Communications
Yoshiaki Sone	NTT	NTT
Mark Kimber	Semtech	Semtech
Peter Stassar	Huawei Technologies	Huawei Technologies
Ali Ghiasi	Ghiasi Quantum	Ghiasi Quantum / Huawei
Nathan Tracy	TE Connectivity	TE Connectivity
David Malicoat	Self	Self / SENKO Advanced Components
Matt Brown	MACOM	MACOM
Vince Ferretti	Corning, Inc	Corning, Inc.
Mark Nowell	Cisco	Cisco
Xinyuan Wang	Huawei	Huawei